

# Miramid® SEP30C

Polyamide 66

BASF Leuna GmbH

Message:

Miramid® SEP30C is a Polyamide 66 (Nylon 66) material filled with 30% glass fiber. It is available in Europe for injection molding.

Important attributes of Miramid® SEP30C are:

Chemical Resistant

Crystalline

Good Stiffness

Impact Modified

Mold Release Agent

Typical applications include:

Automotive

Engineering/Industrial Parts

General Information	
Filler / Reinforcement	Glass Fiber,30% Filler by Weight
Additive	Impact Modifier
	Mold Release
Features	Crystalline
	Fuel Resistant
	Good Flow
	Good Stiffness
	Grease Resistant
	High Rigidity
	Impact Modified
	Oil Resistant
	Solvent Resistant
Uses	Engineering Parts
Forms	Granules
Processing Method	Injection Molding
Multi-Point Data	Isothermal Stress vs. Strain (ISO 11403-1)
	Secant Modulus vs. Strain (ISO 11403-1)

Physical	Dry	Conditioned	Unit	Test Method
Density	1320	--	kg/m <sup>3</sup>	ISO 1183 <sup>1</sup>
Water Absorption				ISO 62 <sup>2</sup>
Saturation	4.8	--	%	
Equilibrium	1.3	--	%	
Mechanical	Dry	Conditioned	Unit	Test Method
Tensile modulus	8000	6000	MPa	ISO 527-2 <sup>3</sup>

Tensile Stress (Break)	140	120	MPa	ISO 527-2 <sup>4</sup>
Tensile Strain (Break)	5.0	6.0	%	ISO 527-2 <sup>5</sup>
Flexural Stress <sup>6</sup>	230	170	MPa	ISO 178
Impact	Dry	Conditioned	Unit	Test Method
Charpy notched impact strength				ISO 179/1eA <sup>7</sup>
-30°C	15.0	--	kJ/m <sup>2</sup>	
23°C	20.0	25.0	kJ/m <sup>2</sup>	
Charpy impact strength				ISO 179/1eU <sup>8</sup>
-30°C	90.0	--	kJ/m <sup>2</sup>	
23°C	100	110	kJ/m <sup>2</sup>	
Thermal	Dry	Conditioned	Unit	Test Method
Deflection Temperature Under Load				ISO 75-2 <sup>9</sup>
0.45 MPa	250	--	°C	
1.8 MPa	240	--	°C	
Melting Temperature (DSC)	260	--	°C	ISO 3146
Electrical	Dry	Conditioned	Unit	Test Method
Volume resistivity	1.0E+13	1.0E+10	ohms·m	IEC 60093 <sup>10</sup>
Dielectric Constant (1 MHz)	3.50	5.50		IEC 60250
Dissipation Factor (1 MHz)	0.015	0.20		IEC 60250 <sup>11</sup>
Comparative tracking index	550	--		IEC 60112 <sup>12</sup>
Injection	Dry	Unit		
Processing (Melt) Temp	280 to 300		°C	
Mold Temperature	80.0 to 100		°C	
NOTE				

1. Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.

2. Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.

3. Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.

4. Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.

5. Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.

6. Typical values for uncoloured product at 23°C and 50% relative humidity

7. Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.

8.	Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.
9.	Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.
10.	Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.
11.	Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.
12.	Tested in accordance with ISO 10350. 23°C/50%r.h. unless otherwise noted.

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#### Recommended distributors for this material

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